









# **CEP12N65**

#### 650V ▲ 610mΩ ▲ 12A ▲ Si MOSFET

SILICON Si MOSFET ▲ THT type
N-channel enhancement mode
UL94V-0 rated flame retardant epoxy
TO220-3L package

Super high dense cell density for extremely low R<sub>DS(ON)</sub> **High power and current handling capability** 

### **MAXIMUM RATINGS**

Parameter ( $T_c$ = 25°C, unless otherwise noted)		Characteristics
Drain-Source Voltage	V <sub>DS</sub>	650V
Gate-Source Voltage	V <sub>GS</sub>	±30V
Continuous Drain Current at T <sub>C</sub> = 25°C	I <sub>D</sub>	12A
Pulsed Drain Current Note 1	I <sub>DM</sub> Note 5	48A
Maximum Power Dissipation at T <sub>C</sub> = 25°C	P <sub>D</sub>	250W
Power Dissipation Derating above 25°C	ΔP <sub>D</sub>	1.67W/°C
Single Pulsed Avalanche Energy Note 6	E <sub>AS</sub>	607mJ
Single Pulsed Avalanche Current Note 6	I <sub>AS</sub>	4.5A
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55°C to +175°C

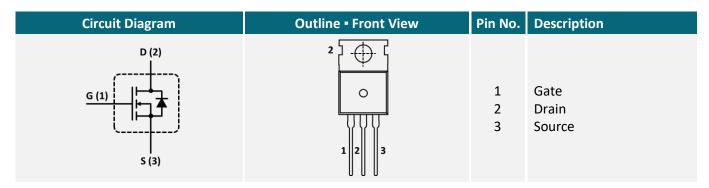
### THERMAL CHARACTERISTICS

Parameter	Symbol	Limit
Thermal Resistance, Junction-to-Case	R <sub>TH_JC</sub>	0.6°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>TH_JA</sub>	62.5°C/W

#### **APPLICATIONS**

EV Charging	Industrial Inverters	Motors & Drives	Power Factor Correction	Renewable Energy	SMPS	UPS
<b>₹</b>			PFC	*		

## **PIN DESCRIPTION**





## **ELECTRICAL CHARACTERISTICS** ▲ T<sub>C</sub> = 25°C, unless otherwise noted

Item	Condition	Symbol	Min.	Тур.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	$V_{GS} = 0V$ , $I_D = 250\mu A$	BV <sub>DSS</sub>	650			V
Zero Gate Voltage Drain Current	$V_{DS} = 650V, V_{GS} = 0V$	I <sub>DSS</sub>			1	μΑ
Gate Body Leakage Current, Forward	$V_{GS} = 30V, V_{DS} = 0V$	$I_{GSSF}$			100	nA
Gate Body Leakage Current, Reverse	$V_{GS} = -30V$ , $V_{DS} = 0V$	I <sub>GSSR</sub>			-100	nA
On Characteristics Note 2						
Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \mu A$	$V_{GS(th)}$	2		4	V
Static Drain-Source On-Resistance	$V_{GS} = 10V, I_D = 5.5A$	R <sub>DS(ON)</sub>		610	730	mΩ
Dynamic Characteristics Note 3						
Input Capacitance	$V_{DS} = 25V$ , $V_{GS} = 0V$ , $f = 1MHz$	C <sub>ISS</sub>		1745		pF
Output Capacitance	$V_{DS} = 25V$ , $V_{GS} = 0V$ , $f = 1MHz$	Coss		205		pF
Reverse Transfer Capacitance	$V_{DS} = 25V$ , $V_{GS} = 0V$ , $f = 1MHz$	$C_{RSS}$		20		pF
Switching Characteristics Note 3						
Turn-On Delay Time	$V_{DD}$ = 300V, $V_{GS}$ = 10V, $I_D$ = 12A, $R_{G(ext)}$ = 25 $\Omega$	t <sub>D(ON)</sub>		31		ns
Turn-On Rise Time	$V_{DD}$ = 300V, $V_{GS}$ = 10V, $I_D$ = 12A, $R_{G(ext)}$ = 25 $\Omega$	$t_R$		129		ns
Turn-Off Delay Time	$V_{DD}$ = 300V, $V_{GS}$ = 10V, $I_D$ = 12A, $R_{G(ext)}$ = 25 $\Omega$	t <sub>D(OFF)</sub>		106		ns
Turn-Off Fall Time	$V_{DD}$ = 300V, $V_{GS}$ = 10V, $I_D$ = 12A, $R_{G(ext)}$ = 25 $\Omega$	t <sub>F</sub>		63		ns
Total Gate Charge	$V_{DS}$ = 400V, $V_{GS}$ = 10V, $I_{D}$ = 12A	$Q_{G}$		45		nC
Gate Source Charge	$V_{DS}$ = 400V, $V_{GS}$ = 10V, $I_{D}$ = 12A	$Q_{GS}$		8		nC
Gate Drain Charge	$V_{DS} = 400V$ , $V_{GS} = 10V$ , $I_D = 12A$	$Q_{GD}$		21		nC
<b>Drain-Source Diode Characteristics a</b>	nd Maximum Ratings					
Drain-Source Diode Forward Current		Is			12	Α
Drain-Source Diode Forward Voltage Note 2	V <sub>GS</sub> = 0V, I <sub>S</sub> = 12A	$V_{SD}$			1.4	V

#### Notes

- 1: Repetitive Rating: Pulse width limited by maximum junction temperature
- 2: Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 3: Guaranteed by design, not subject to production testing.
- 4: Limited only by maximum temperature allowed.
- 5: Pulse width limited by safe operating area.
- 6: L = 60mH,  $I_{AS}$  = 4.5A,  $V_{DD}$  = 50V,  $R_G$  = 25Ω, Starting  $T_J$  = 25°C



#### REFERENCE DATA A TYPICAL DEVICE PERFORMANCE



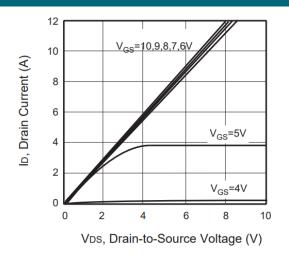


Fig. 2 • Transfer Characteristics

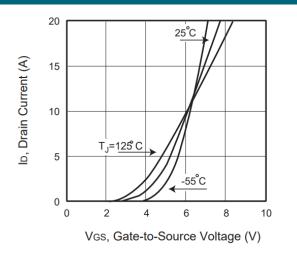


Fig. 3 • Capacitance

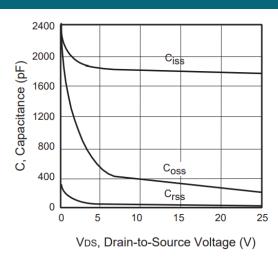


Fig. 4 • On-Resistance Variation with Temperature

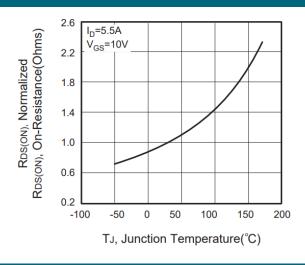


Fig. 5 • Gate Threshold Variation with Temperature

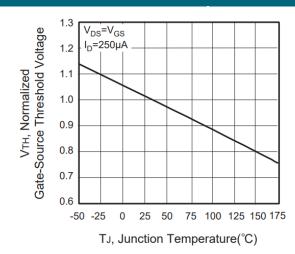
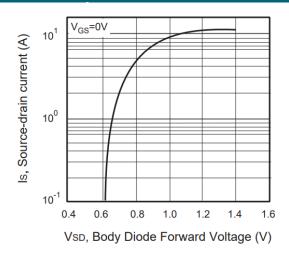


Fig. 6 • Body Diode Forward Voltage Variation with Source Current

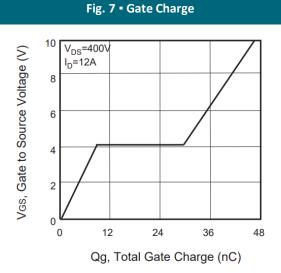


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#### REFERENCE DATA A TYPICAL DEVICE PERFORMANCE



10<sup>2</sup> R<sub>DS(ON)</sub>Limit lb, Drain Current (A) 100ແຮ 10<sup>1</sup> 10<sup>0</sup> T<sub>C</sub>=25°C T<sub>J</sub>=175°C Single Pulse 10<sup>-1</sup> 10<sup>0</sup>

Fig. 8 • Maximum Safe Operating Area

Fig. 9 • Switching Test Circuit

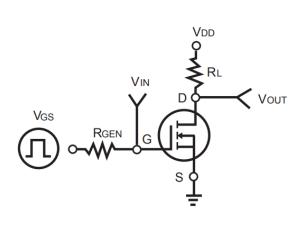
Fig. 10 • Switching Waveforms

VDS, Drain-Source Voltage (V)

10<sup>1</sup>

10<sup>2</sup>

10<sup>3</sup>



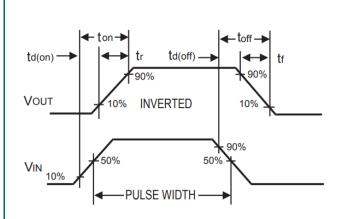
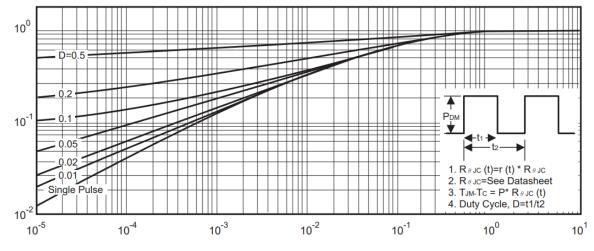


Fig. 11 - Normalized Thermal Transient Impedance Curve



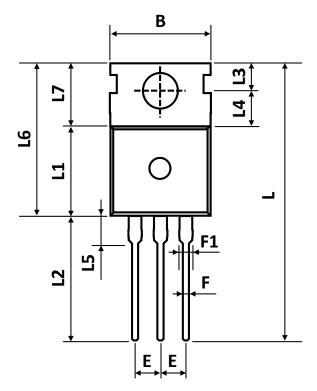


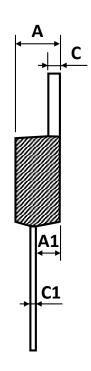
Square Wave Pulse Duration (msec)

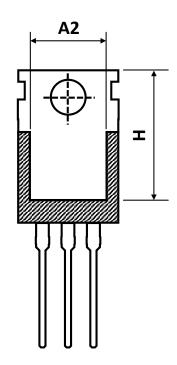
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## **PACKAGE OUTLINE**







Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
Α	4.43	4.53	4.63
A1	2.30	2.40	2.50
A2	7.70	7.90	8.10
В	9.80	10.00	10.20
С	1.25	1.30	1.40
C1	0.45	0.50	0.60
D	3.45	3.60	3.70
E	2.45	2.54	2.60
F	0.70	0.80	0.95
F1	1.15	1.33	1.50
L	26.80	28.80	30.80
L1	9.20	9.30	9.40
L2	12.80	13.10	13.40
L3	2.70	2.80	2.90
L4	3.50	3.70	3.80
L5	2.60	2.90	3.20
L6	15.40	15.80	16.20
L7	6.20	6.50	6.80
Н	12.95	13.25	13.55

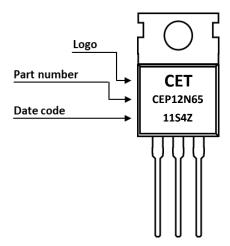
## **ORDERING INFORMATION**

Part Number	Package	Packing	Tube Qty.	Inner Box Qty.	Outer Box Qty.
CEP12N65	TO-220-3L	Tube	50pcs	1,000pcs	4,000pcs

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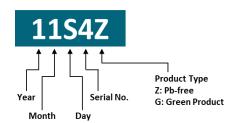


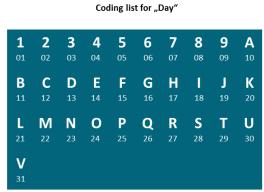
#### **PART MARKING**



#### **DATE CODE**

Example: 11S4Z

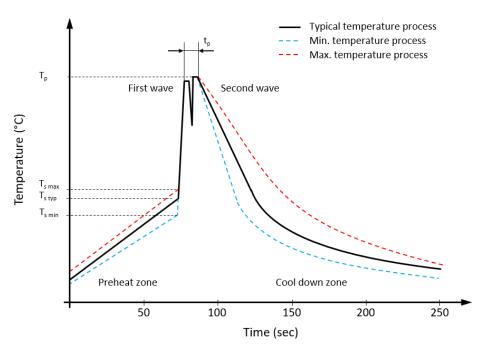








### RECOMMENDED WAVE SOLDERING PROFILE A THT PACKAGE



## Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

Profile Features		Value ▲ Sn-Pb Assembly	Value ▲ Pb-free Assembly
Preheat temperature min.	$T_{smin}$	100 °C	100 °C
Preheat temperature typical	T <sub>s typ</sub>	120 °C	120 °C
Preheat temperature max.	$T_{smax}$	130 °C	130 °C
Preheat time $t_s$ from $T_{smin}$ to $T_{smax}$	ts	70 seconds	70 seconds
Peak temperature	$T_p$	235 °C to 260 °C	245 °C to 260 °C
Time of actual peak temperature	t <sub>p</sub>	Max. 10 seconds Max. 5 second each wave	Max. 10 seconds Max. 5 second each wave
Ramp-down date min.		~ 2 °C/second	~ 2 °C/second
Ramp-down rate typical		~ 3.5 °C/second	~ 3.5 °C/second
Ramp-down rate max.		~ 5 °C/second	~ 5 °C/second
Time 25°C to 25°C		4 minutes	4 minutes



#### **REVISION TABLE**

Revision	Date	Status	Notes
001	30/09/2022	Initial release	Initial publication

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